

PACKAGE DIMENSIONS 0.200 (5.08) 0.180 (4.57) 0.350 (8.89) 0.040 (1.02) 0.330 (8.38) 1.00 (25.4) MIN 0.050 (1.27) 0.050 (1.27) REF. 0.100 (2.54) -0.100 (2.54) Ø 0.230 (5.84) **FLAT DENOTES** 0.023 (0.58) 0.017 (0.43) SQ. TYP. (2X) CATHODE

SUPER GREEN MV8R0X MV8R01 MV8R03

FEATURES

- Popular T-1 3/4 package
- Super high brightness suitable for outdoor applications
- Solid state reliability
- Water clear optics
- Standard 100 mil. lead spacing



NOTES:

- 1. Dimensions for all drawings are in inches (mm).
- 2. Lead spacing is measured where the leads emerge from the package.
- 3. Protruded resin under the flange is 1.5 mm (0.059") max.

DESCRIPTION

This T-1 3/4 super bright LED has a moderate viewing angle of 20° for concentrated light output. It is made with an InGaN LED that emits green light at 520 nm. It is encapsulated in a water clear epoxy lens package.

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)				
Parameter	Symbol	Rating	Unit	
Operating Temperature	T _{OPR}	-20 to +80	°C	
Storage Temperature	T _{STG}	-30 to +100	°C	
Lead Soldering Time	T _{SOL}	260 for 5 sec	°C	
Continuous Forward Current	I _F	30	mA	
Peak Forward Current (f = 1.0 KHz, Duty Factor = 1/10)	I _F	100	mA	
Reverse Voltage	V _R	5	V	
Power Dissipation	P _D	120	mW	



SUPER GREEN	MV8R0X
MV8R01	
MV8R03	

Part Number	MV8R01	MV8R03	Condition
Luminous Intensity (mcd)			I _F = 20 mA
Minimum	1500	3000	
Typical	1900	3500	
Forward Voltage (V)			I _F = 20 mA
Maximum	4.2	4.2	
Typical	3.6	3.6	
Wavelength (nm)			I _F = 20 mA
Peak	52	20	
Dominant	52	25	
Spectral Line Half Width (nm)	4	10	I _F = 20 mA
Viewing Angle (°)	2	20	I _F = 20 mA

TYPICAL PERFORMANCE CURVES

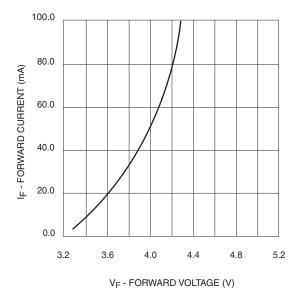


Fig. 1 Forward Current vs. Forward Voltage

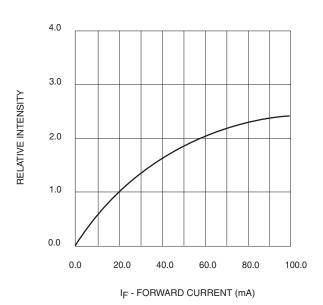


Fig. 2 Relative Luminous Intensity vs.
Forward Current



SUPER GREEN MV8R0X MV8R01 MV8R03

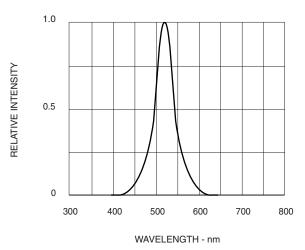
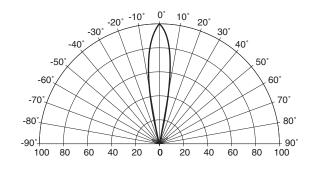


Fig. 3 Relative Luminous Intensity vs. Wavelength



REL. LUMINOUS INTENSITY (%)

Fig. 4 Radiation Diagram



DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com

© 2000 Fairchild Semiconductor Corporation